

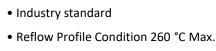
SPECIFICATION SHEET

	1
SPECIFICATION SHEET NO.	N0916- YV32K76800S003
DATE	Sept. 16, 2021
REVISION	AO
DESCRIPITION	KHz SMD Crystals, L1.6*W1.0*H0.5mm, 2 Pads, CCMV series
	32.76800KHz, +/-20ppm, CL 7pF
	Operating Temp. Range -40°C ~+85°C, ESR 90 Kohm Max.
	Reflow Profile Condition 260 °C Max.
	Tape/Reel, 5000pcs/Reel,
	RoHS/RoHS III compliant
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CCMV 32K768A20-7-40-90TLF
PART CODE	YV32K76800S003

VENDOR APPROVE			
lssued/Checked/Approved	So mpore	Compose Ruby Zhang To _A /3001	Jack Trans
DATE: Sept. 16, 2021			

DATE:

CUSTOMER APPROVE



MAIN FEATURE

• Cross more competitors part

• RoHS/RoHS III compliant

APPLICATION

Small communications devices and more

PART CODE GUIDE

YV	32K76800	S	003
1	2	3	4

1) YV: Part family Code for KHz SMD Crystal, Dimension L1.6*W1.0*H0.5mm, 2 Pads, CCMV series

2) 32K76800: Frequency range code for 32.76800KHz

3) S: SMD type, Package Tape/Reel, 5000pcs/Reel

4) 003: Specification code for original part No.: TGS CCMV 32K768A20-7-40-90TLF

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• SMD Package, CCMVSeries, L1.6*W1.0*H0.5mm, 2 Pads



PART CODE: YV32K76800S003

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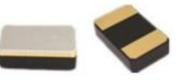




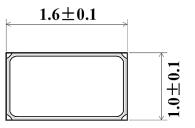
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DIMENSION (Unit: mm)

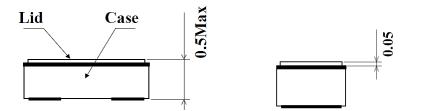
Image for reference

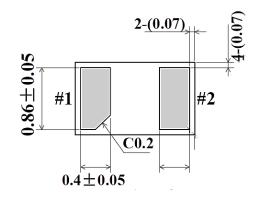




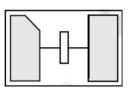


Marking Internal Control Code





Internal Connection for reference



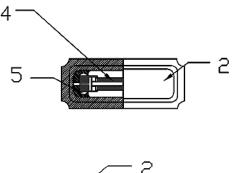
<Top View>

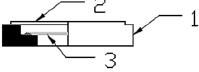
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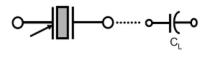
PRODUCT STRUCTURE

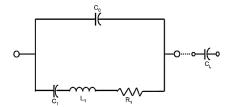




ltem No.	Component Name	Material Name
1	Crystal Case	Ceramic (A1203)
2	Crystal Cover/Lid	KV (Fe/Co/Ni)
3	Crystal Chip/Blank	SiO2
4	Electrode	Au, Ag
5	Adhesive	Resin, Ag

EQUIVALENT CIRCUIT





NOTES BEFORE USE

Ultrasonic Cleaning:

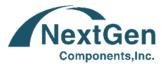
General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in device and even damage the overall structure of device. Therefore, verification test is recommended before cleaning.

Ultrasonic Welding

Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and become the cause of characteristic deterioration and not oscillating.

Storage Temperature Description

Storage Temperature is only for the product itself, the temperature for the packing material is 5~40°C Recommended Conditions for Manual Welding Max. Temperature: 350±10°C, Time: 3 sec Max., Re-solder time: twice Max.



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ELECTRICAL PARAMETERS

Parameter		Part No. Symbol	Units	Value			Condition
		Symbol		Min.	Typical	Max.	
Original	Manufacturer	TGS		TGS Crystals			
Holder 1	Гуре	CCMV	KHz SMI	O Crystal, L1.6	5*W1.0*H0.5mm	n, 2 Pads	
Frequer	icy Range	32K768	KHz		32.76800		
Mode o	f Oscillation	А			AT Fundament	al	
Frequen	icy Tolerance	20	ppm	-20		+20	@25°C
Load Ca	pacitance	-7	pF		7.0	I	
Frequer Coefficie	ncy/Temp ent		ppm/°C²	-0.04	-0.03	-0.02	
Operation Temperation		-40	°C	-40		+85	
Storage	Temperance		°C	-55		+125	
	ent Series nce (ESR)	-90	ΚΩ			90	Ref to 25°C
Drive Le	vel		μW		0.1	0.5	
Shunt C (C0)	apacitance		Pf		1.4	7.0	
Dynami (C1)	c Capacitance		fF		6.0		
Turnove	er Temp		°C	+20	+25	+30	
Quality	Factor				10,000		
Capacita	ance Ratio				450		
Aging			ppm/year			±3	@1 st year 25+/-3°C
Insulatio	on Resistance		MΩ	500			@100VDC ± 15VDC
	Package	Т	Tape/Reel, 5000pcs/Reel				
	RoHS Status	LF		RoHS II	l compliant		
Other	Add Value				N/A		
	Special Code <mark>*</mark>			2 letters or digits; Blank: N/A			

Note: 1) Original Part Number: TGS CCMV 32K768A20-7-40-90T LF

2) * Internal Control Code- 2 letter or digits; Blank: N/A





KHZ SMD CRYSTALS CCMV SERIES 1610 TYPE

RELIABILITY

Test Items	Test Method And Conditions	Test Standard
High Temperature High Humidity Storage	Temperature: 60°C ± 2 °C Relative Humidity: 90%~95% RH For Time: 500 ± 12 Hours	A, C, D, G
High Temperature Storage	Temperature: 125°C ± 2°C Time: 1000±12 Hours.	B, C, G
Low Temperature Storage	Temperature: -40°C ± 2°C Time: 500 ± 12 Hours.	A, C, G
Temperature Cycle	The crystal unit shall be subjected to 100 successive change of temperature cycles. $+25\pm2^{\circ}C$ $-40+0/-6^{\circ}C$ $30\pm3min$ $3min. max.$ $1 Cycle$	A, C, G
Solderability	The solder pot temperature is 260±5°C , dwell time 2±0.6sec	F
Drop Test	Height: 180 cm; Dropped Cycle: 3 cycles; Drop it on to a concrete board for 6 Directions (X,Y,Z), that should be 1 cycle	В, С
Vibration	Frequency Range: 10Hz ~ 55Hz Amplitude: 1.5mm±15%; Sweep time: 2~3 Minutes, 2 Hours in each direction, total 6 Hours	Α, C
Leakage Test	Helium Bombing 5.0 ~5.5 Kgf/cm ² ; for 2 hours	E



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RELIABILITY

Test Items	Test Method And Conditions	Test Standard
Terminal Strength	Shall be pressurized at a speed of approx. 0.5mm/sec. in the direction indicated by the arrow unit the bending width reaches 3mm and held for 5 sec. $\begin{array}{c c} & & & \\ &$	B, C
Sticking Tendency	A R0.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.	B, C
Element Assembly Strength	A R0.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.	B, C

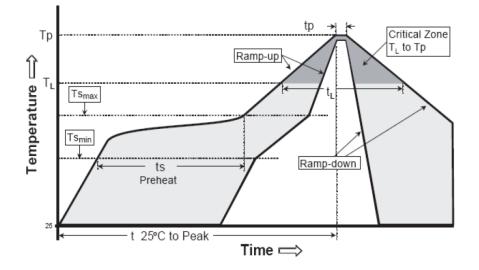
TEST STANDARD

Test Standard Symbol	Specification	Value
А	Frequency Change permitted	ΔF≤10ppm
В	Frequency Change permitted	∆F≤20ppm
С	Equivalent Series Resistance Change Permitted	ΔCI≤5KΩ or 20%
D	Insulation Resistance	>500 MΩ
E	Leak Rate Less than <1*1E-9 Pa • m ³ ,	
F	A new uniform coating of solder shall cover a Min 95% of the crystal surface	
G	Then 25 ± 2°C over 2 hours before Testing	

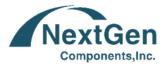


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SUGGESTED REFLOW PROFILE (For Reference No. JEDEC J-STD-020D)



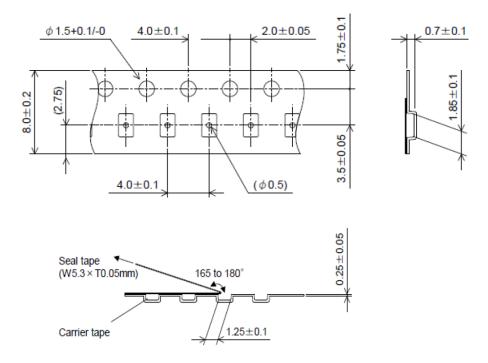
Profile Feature		Pb-Free Assembly
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 120 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		260 +/-5°C
Time within 5°C of a	actual Peak Temperature (tp)	20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 $^{\circ}\mathrm{C}$ to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.



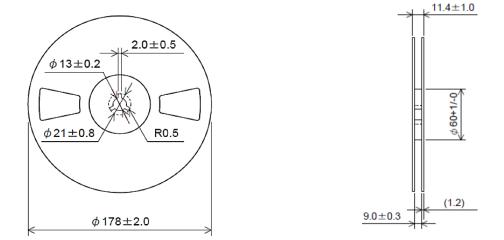
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TAPE (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications, 3000pcs/Reel



REEL 5000pcs/Reel (Unit: mm)



DISCLAIMER

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